Applicant: Isamu Kobori, et al.

Serial No.: 10/713,275

Filed: November 17, 2003

Page : 2 of 9

Amendments to the Claims

This listing of claims replaces all prior versions and listings of claims in the application.

Listing of Claims

1-15. (Canceled)

- 16. (Previously Presented) An active matrix circuit comprising:
- a semiconductor layer;
- a p-type impurity region provided in said semiconductor layer;
- a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer;
- a conductive layer comprising titanium and aluminum over said first interlayer insulating film; and
- a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer,

wherein said titanium and said aluminum are formed in a multi-layer film.

- 17. (Previously Presented): A circuit according to claim 16 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 18. (Previously Presented): A circuit according to claim 16 wherein said active matrix circuit is incorporated into an image sensor.
- 19. (Previously Presented): A circuit according to claim 16 wherein said active matrix circuit is incorporated into a liquid-crystal electro-optical device.
- 20. (Previously Presented): A circuit according to claim 16 wherein said semiconductor layer comprises a crystal silicon.

Applicant: Isamu Kobori, et al.

Serial No.: 10/713,275

Filed: November 17, 2003

Page : 3 of 9

21. (Previously Presented): An active matrix circuit comprising:

a semiconductor layer;

- a p-type impurity region provided in said semiconductor layer;
- a first interlayer insulating film comprising a silicon nitride layer and a silicon oxide layer, said first interlayer insulating film provided over said semiconductor layer;
- a conductive layer comprising titanium and aluminum over said first interlayer insulating film; and
- a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer.
- 22. (Previously Presented): A circuit according to claim 21 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 23. (Previously Presented): A circuit according to claim 21 wherein said active matrix circuit is incorporated into an image sensor.
- 24. (Previously Presented): A circuit according to claim 21 wherein said active matrix circuit is incorporated into a liquid-crystal electro-optical device
- 25. (Previously Presented): A circuit according to claim 21 wherein said semiconductor layer comprises a crystal silicon.
 - 26. (Previously Presented): An active matrix circuit comprising:
 - a semiconductor layer:
 - a p-type impurity region provided in said semiconductor layer;
- a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer;

Applicant: Isamu Kobori, et al.

Serial No.: 10/713,275

Filed: November 17, 2003

Page : 4 of 9

a conductive layer comprising titanium and aluminum over said first interlayer insulating film; and

a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer.

- 27. (Previously Presented): A circuit according to claim 26 wherein said conductive layer comprises an electrode.
- 28. (Previously Presented): A circuit according to claim 26 wherein said conductive layer comprises a wiring.
- 29. (Previously Presented): A circuit according to claim 26 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 30. (Previously Presented): A circuit according to claim 26 wherein said active matrix circuit is incorporated into an image sensor.
- 31. (Previously Presented): A circuit according to claim 26 wherein said active matrix circuit is incorporated into a liquid-crystal electro-optical device.
- 32. (Previously Presented): A circuit according to claim 26 wherein said semiconductor layer comprises a crystal silicon.
 - 33. (Canceled).
 - 34. (New): An active matrix circuit comprising:
 - a semiconductor layer;
 - a p-type impurity region provided in said semiconductor layer;

Applicant: Isamu Kobori, et al.

Serial No.: 10/713,275

Filed: November 17, 2003

Page : 5 of 9

a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer;

a conductive layer comprising titanium and aluminum over said first interlayer insulating film, said conductive layer connected with said p-type impurity region; and

a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer,

wherein said titanium and said aluminum are formed in a multi-layer film.

- 35. (New): A circuit according to claim 34 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 36. (New): A circuit according to claim 34 wherein said active matrix circuit is incorporated into an image sensor.
- 37. (New): A circuit according to claim 34 wherein said semiconductor layer comprises a crystal silicon.
 - 38. (New): An active matrix circuit comprising:
 - a semiconductor layer;
 - a p-type impurity region provided in said semiconductor layer;
- a first interlayer insulating film comprising a silicon nitride layer and a silicon oxide layer, said first interlayer insulating film provided over said semiconductor layer;
- a conductive layer comprising titanium and aluminum over said first interlayer insulating film, said conductive layer connected with said p-type impurity region; and
- a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer.

Applicant: Isamu Kobori, et al.

Serial No.: 10/713,275

: November 17, 2003 : 6 of 9 Filed

Page

39. (New): A circuit according to claim 38 wherein said active matrix circuit is incorporated into a liquid-crystal display.

- 40. (New): A circuit according to claim 38 wherein said active matrix circuit is incorporated into an image sensor.
- 41. (New): A circuit according to claim 38 wherein said semiconductor layer comprises a crystal silicon.
 - 42. (New): An active matrix circuit comprising:
 - a semiconductor layer:
 - a p-type impurity region provided in said semiconductor layer;
- a first interlayer insulating film comprising silicon nitride provided over said semiconductor layer;
- a conductive layer comprising titanium and aluminum over said first interlayer insulating film, said conductive layer connected with said p-type impurity region; and
- a second interlayer insulating film provided over said conductive layer to provide a leveled upper surface over said semiconductor layer.
- 43. (New): A circuit according to claim 42 wherein said active matrix circuit is incorporated into a liquid-crystal display.
- 44. (New): A circuit according to claim 42 wherein said active matrix circuit is incorporated into an image sensor.
- 45. (New): A circuit according to claim 42 wherein said semiconductor layer comprises a crystal silicon.